



友順科技股份有限公司

UNISONIC TECHNOLOGIES CO., LTD

產 品 變 更 通 知

PRODUCT CHANGE NOTIFICATION

PCN No.	IC-PCN-151101	Issue Date	2015.11.18
TITLE	DIP-8 新增替代樹脂( implement alternative compound of DIP-8 package )		Page 1 of 2

變更主旨(TITLE):

新增DIP-8 替代樹脂

Implement alternative compound of DIP-8 package.

變更類別(CATEGORY):

- Design     
  Process     
  Raw Material     
  Manufacturing Site  
 Testing     
  Packing/Shipping/Labeling     
  Other \_\_\_\_\_

變更說明(DESCRIPTION OF CHANGE):

因應產能提升需求，故新增DIP-8替代樹脂，詳細比較請參閱附件。

UTC implement alternate compound of DIP-8 package production because of enhance production capacity.

	變更前(Before)	變更後(After)
molding compound	KH-9200	EME-2500 KH-9200

品質驗證(QUALIFICATION AND RELIABILITY DATA):

指定產品均通過封裝可靠性測試，且不影響原承認書保證之特性。(請參考可靠度報告)

No change to electrical specification in approval datasheet, and package reliability test were qualified in the specific product.(Refer to reliability report)

變更識別(IDENTIFICATION METHOD TO DISTINGUISH CHANGE)

新樹脂產品可用D/C及製造工令來進行批次管控及追溯，現有庫存品繼續出貨至用罄後全面供應，實際交貨依客戶之要求。

New compound (EME-2500) is going to be controlled by Production Order and the delivered product can be tracing by D/C and Work Order number.



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**生效日期(EFFECTIVE DATE OF CHNAGE):**

Feb-18-2016

為維護貴我權益，請在收到通知30日內回覆貴司意見，以利變更順利執行。若未蒙貴司回覆，將依照通知函內容登錄之起始時間執行此項變更

UTC will consider this change approved unless specific requests are addressed in writing within 30 days of receipt of this PCN.

**適用範圍(APPLICABLE PRODUCTS):**

DIP-8 package.

友順對此變更所引起之不便表達致歉，如果對本變更有任何問題，請與我們的業務代表或經銷商聯絡。

We apologize for any inconvenience causing from this change, If you have any questions concerning this change, please contact your local sales or UTC's sales representative.